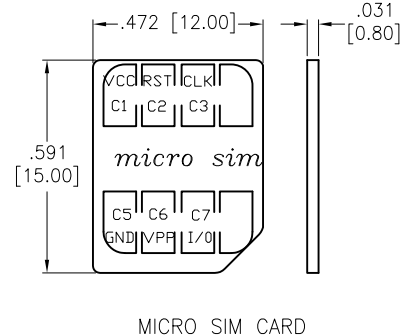
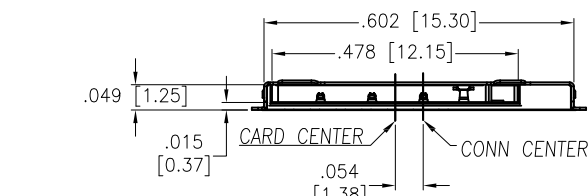
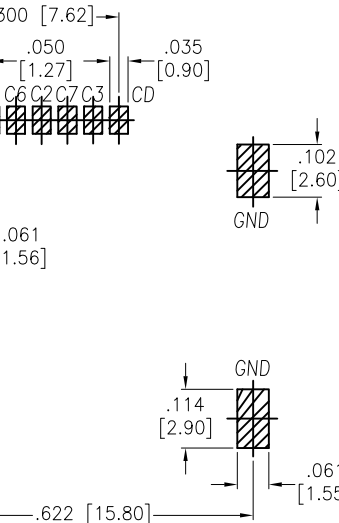
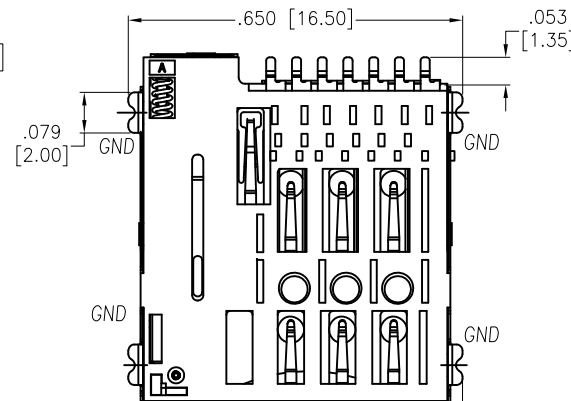
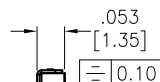
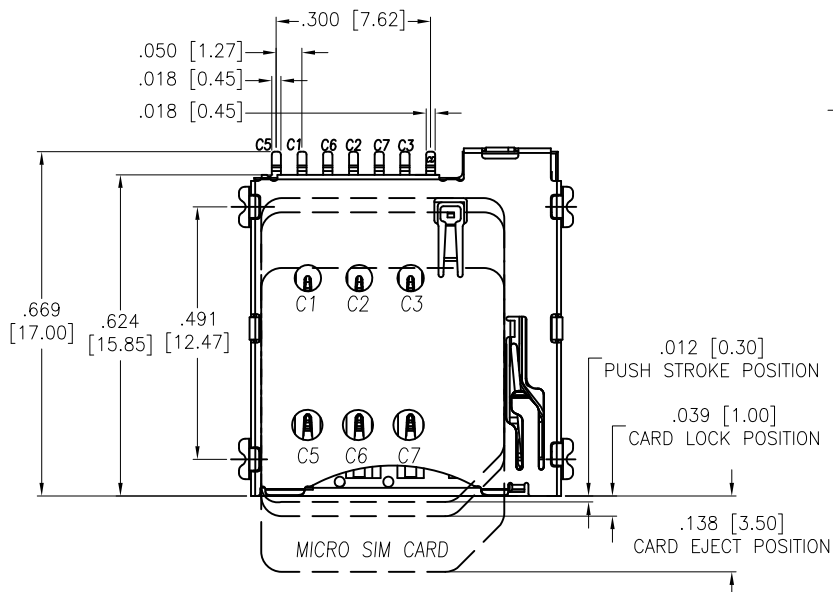


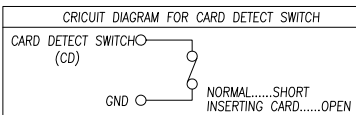
APPROVED: _____

DATE: _____ TITLE: _____

Rev	AWO #	Description	Date	Appr
-		RELEASED	9/12/16	
A		ADDED CRICUIT DIAGRAM	11/16/17	AY/RT
B		UPDATE SPEC.	3/27/18	AY/YC



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



SPECIFICATIONS:

Material:
Insulation: Hi-Temp Thermoplastic, UL94V-0, Color: Black
Contact: Copper Alloy
Shell: Stainless, Nickel plated, 1u" Gold over Nickel underplate on contact area
Plating:
Gold flash over Nickel underplate on contact area
Electrical:
Voltage rating: 10V DC
Current rating: 0.5 mA AC/DC max
Contact resistance: 100 mohms Max.
Insulation resistance: 1,000 Mohms min @ 500 VDC
Temperature Rating:
Operating temperature: -40°C to +85°C
Environmental:
Lead free, RoHS compliant



■ CIRCUIT TRACE KEEP OUT AREA
■ SMT SOLDER AREA

PACKAGED ON TAPE & REEL

UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE INCHES [MM] TOLERANCES: EXCEPT AS NOTED INCHES HOLES .X ±.10 Ø.X ±.10 .XX ±.020 Ø.XX ±.015 .XXX ±.015 Ø.XXX ±.010		ADAM TECH INTERCONNECTS		909 Rahway Avenue, Union, NJ 07083 Phone: 908-687-5000 Fax: 908-687-5710	
APPROVALS		DATE		TITLE	
DRAWN AY		9/12/16		MICRO SIM CARD CONNECTOR, PUSH-PUSH	
CHECKED SC		9/12/16		TYPE, 6 PIN, SEL-GOLD PLATED, TAPE & REEL	
APPROVED				SIZE X	PART NO. MSCCP-A1-06-SG-SW-T/R
				REF: S00275T	SCALE: NTS
				SHEET 1 OF 1	